

Amendments to the Claims

This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

1. (currently amended) A process for cleaning metals comprising a step the steps of
(a) contacting a metal with an aqueous solution comprising hydrogen peroxide, at least one mineral acid, and at least one compound selected from the group consisting of complexing agents based on phosphonic acids, salts and degradation products thereof in an amount from about 10 to about 60 wt% based on the amount of hydrogen peroxide; and
(b) cleaning said metal via said contacting step.
2. (original) A process as claimed in claim 1, wherein the aqueous solution comprises at least one compound selected from the group consisting of complexing agents based on phosphonic acids, salts and degradation products thereof in an amount from about 20 to about 50 wt% based on the amount of hydrogen peroxide.
3. (original) A process as claimed in claim 2, wherein the aqueous solution comprises at least one compound selected from the group consisting of complexing agents based on phosphonic acids, salts and degradation products thereof in an amount from about 35 to about 45 wt% based on the amount of hydrogen peroxide.
4. (original) A process as claimed in claim 1, wherein the complexing agent is based on at least one compound selected from the group consisting of 1-hydroxyethylidene-1, 1-diphosphonic acid, 1-aminoethane-1, 1-diphosphonic acid, aminotri (methylenephosphonic acid), ethylene diamine tetra (methylenephosphonic acid), hexamethylene diamine tetra (methylenephosphonic acid), diethylenetriamine

penta (methylenephosphonic acid), diethylenetriamine hexa (methylenephosphonic acid), salts and degradation products thereof.

5. (original) A process as claimed in claim 4, wherein the complexing agent is based on at least one compound selected from the group consisting of 1-hydroxyethylidene-1, 1-diphosphonic, salt and degradation products thereof.

6. (original) A process as claimed in claim 1, wherein the solution comprises hydrogen peroxide in an amount from about 0.5 to about 20 wt%.

7. (canceled)

8. (original) A process as claimed in claim 7, wherein the solution comprises sulfuric acid.

9. (original) A process as claimed in claim 8, wherein the solution comprises sulfuric acid in an amount from about 0.5 to about 20 wt%.

10. (original) A process as claimed in claim 1, wherein the solution comprises at least one surfactant.

11. (original) A process as claimed in claim 10, wherein the solution comprises at least one non-ionic surfactant.

12. (original) A process as claimed in claim 1, wherein the metal is selected from the group consisting of aluminium, copper and steel.

13. (currently amended) A process for cleaning metals comprising a step the steps of

(a) contacting a metal with an aqueous solution comprising sulfuric acid in an amount from about 0.5 to about 20 wt% hydrogen peroxide and at least one compound

selected from the group consisting of complexing agents based on phosphonic acids, salts and degradation products thereof in an amount from about 35 to about 50 wt% based on the amount of hydrogen peroxide; and

(b) cleaning said metal via said contacting step.

14. (original) A process as claimed in claim 13, wherein the complexing agent is based on at least one compound selected from the group consisting of 1-hydroxyethylidene-1, 1-diphosphonic, salts and degradation products thereof.

15. (currently amended) A process for cleaning metals comprising ~~a step the~~ the steps of

(a) contacting a metal with an aqueous solution comprising alkali metal hydroxide at least one mineral acid, at least one non-ionic surfactant surfactant, hydrogen peroxide and at least one compound selected from the group consisting of complexing agents based on phosphonic acids, salts and degradation products thereof in an amount from about 10 to about 60 wt% based on the amount of hydrogen peroxide; and

(b) cleaning said metal via said contacting step.

16. (original) A process as claimed in claim 15, wherein the complexing agent is based on at least one compound selected from the group consisting of 1-hydroxyethylidene-1, 1-diphosphonic, salts and degradation products thereof.